

## MOSFET Maximum Ratings T<sub>A</sub> = 25°C unless otherwise noted

Symbol	Parameter		Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage		250	V	
V <sub>GS</sub>	Gate to Source Voltage		±20	V	
-	Drain Current -Continuous	(Note 1a)	3.0	٨	
D	-Pulsed		50	— A	
E <sub>AS</sub>	Single Pulse Avalanche Energy	(Note 3)	12.5	mJ	
n	Power dissipation	(Note 1a)	2.5	w	
P <sub>D</sub>	Power dissipation	(Note 1b)	1.0	~ ~ ~	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range		-55 to 150	°C	

# **Thermal Characteristics**

$R_{\thetaJA}$	Thermal Resistance, Junction- to -Ambient	(Note 1a)	50	
$R_{\theta JA}$	Thermal Resistance, Junction- to- Ambient	(Note 1b)	125	°C/W
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction -to- Case	(Note 1)	25	

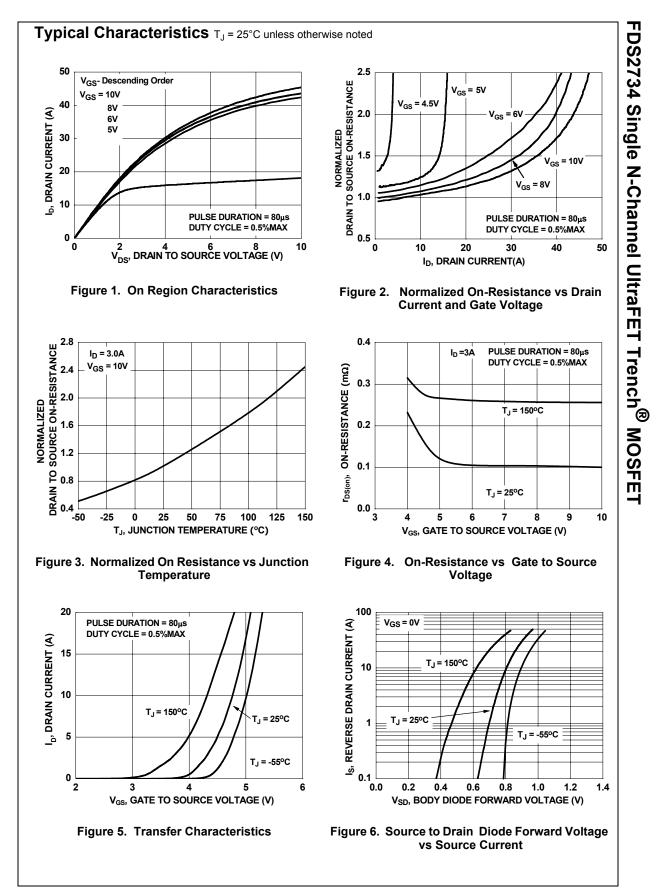
# **Package Marking and Ordering Information**

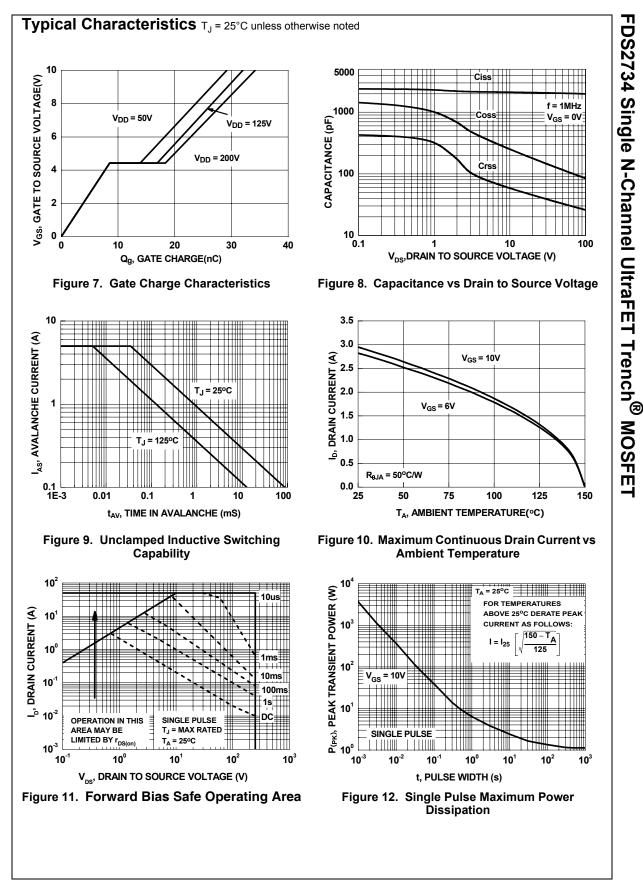
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDS2734	FDS2734	SO-8	13"	12mm	2500 units

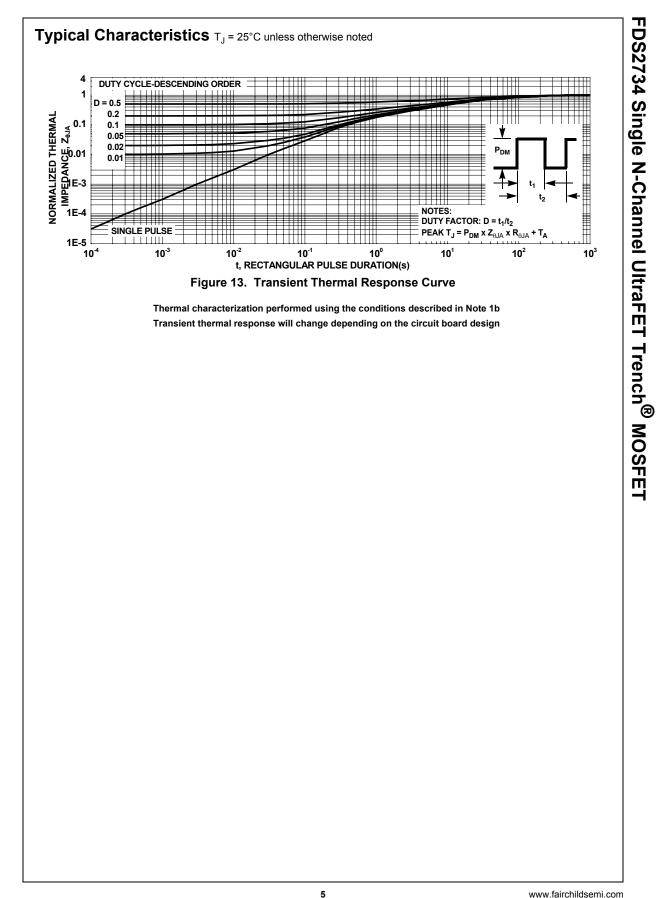
FDS2734 Single N-Channel UltraFET Trench<sup>®</sup> MOSFET

Off Charac BV <sub>DSS</sub> ∆BV <sub>DSS</sub>	Parameter	Test Conditions	Min	Тур	Max	Units
BV <sub>DSS</sub>	teristics					
∆BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250μA, V <sub>GS</sub> = 0V	250			V
$\Delta T_{J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250\mu$ A, referenced to $25^{\circ}$ C		157		mV/ºC
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 200V, V_{GS} = 0 V$ $V_{DS} = 200V, V_{GS} = 0V$ $T_{J} = 55^{\circ}C$			1 10	μΑ
I <sub>GSS</sub>	Gate to Source Leakage Current	V <sub>GS</sub> = ±20V, V <sub>DS</sub> =0 V			±100	nA
On Charac	teristics (Note 2)			•		
	, <i>,</i>		2	2	4	V
$V_{GS(th)}$ $\Delta V_{GS(th)}$	Gate to Source Threshold Voltage Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250\mu A$ $I_D = 250\mu A$ , referenced to $25^{\circ}C$	2	3 -10.7	4	V mV/ <sup>c</sup>
$\Delta T_{J}$	Temperature Coefficient	V <sub>GS</sub> = 10V, I <sub>D</sub> = 3.0A,		97	117	
(DC(cr))	Drain to Source On Resistance	$V_{GS} = 10V, I_D = 3.0A,$ $V_{GS} = 6V, I_D = 2.8A,$		101	126	mΩ
r <sub>DS(on)</sub>		$V_{GS} = 10V, I_D = 3.0A, T_J = 125^{\circ}C$		205	225	
9 <sub>FS</sub>	Forward Transconductance	$V_{\rm DS}$ =10V, I <sub>D</sub> =3.0A,		15.1		s
	Characteristics			1	1	1
C <sub>iss</sub>	Input Capacitance			1960	2610	pF
C <sub>oss</sub>	Output Capacitance	$-V_{DS} = 100V, V_{GS} = 0V,$		85	130	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	f = 1MHz		26	40	pF
R <sub>G</sub>	Gate Resistance	f = 1MHz		0.7		Ω
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub>	Rise Time Turn-Off Delay Time Fall Time	$V_{DD} = 125V, I_D = 3A$ $V_{GS} = 10V, R_{GS} = 6\Omega$		11 40 11	19 64 19	ns ns ns
Qg	Total Gate Charge	V <sub>DS</sub> = 125V, V <sub>GS</sub> = 10V		32	45	nC
Q <sub>gs</sub>	Gate to Source Gate Charge	$I_D = 3.0A$		9		nC
Q <sub>gd</sub>	Gate to Drain Charge			8		nC
	rce Diode Characteristics					
V <sub>SD</sub>	Source to Drain Diode Voltage	I <sub>SD</sub> = 3.0A		0.74	1.2	V
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 3.0 A, d <sub>iF</sub> /dt = 100A/μs		72	108	ns
Q <sub>rr</sub>	Reverse Recovery Charge			185	278	nC

FDS2734 Single N-Channel UltraFET Trench<sup>®</sup> MOSFET







FDS2734 Rev. B

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